

CrossLink I2C Hardened IP Usage Guide

Technical Note



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1. Introduction

CrossLink™ from Lattice Semiconductor is a programmable video bridging device that supports a variety of protocols and interfaces for mobile image sensors and displays. The device is based on Lattice mobile FPGA technology. It combines the extreme flexibility of an FPGA with the low power, low cost and small footprint of an ASIC.

CrossLink devices include integrated I²C blocks to interface with virtually all mobile sensors and application processors. CrossLink devices provide two I²C IP cores. The I2CO core has dedicated I/O pins, called SCL and SDA, on the pinout spreadsheet. These pins are used for I²C programming and support the device sleep mode wakeup over I²C function. The USER SCL and USER SDA pins from the I2C1 core can be connected to any pin on the device.

This document provides guidance for the usage of the Lattice Semiconductor CrossLink I²C IP. It explains the steps and configuration settings required to generate the I²C module using the Lattice Diamond® Clarity Designer tool.

Advanced CrossLink I2C Hardened IP Reference Guide (FPGA-TN-02020) supplements this document.

2. I²C IP Core Overview

The I²C hard IP provides industry standard two-pin communication interface that conforms to the I²C Bus Specification version 2.1. It may be configured in either Master or Slave mode.

In Master mode, it supports configurable data transfer rate and performs arbitration detection to allow it to operate in multi-master systems. It supports clock stretching in both Master and Slave modes with enable/disable capability.

It supports both 7 bits and 10 bits addressing in Slave mode with configurable Slave address. It supports general call address detection in both Master and Slave mode.

It provides interrupt logic for easy communicating with host. It also provides configurable digital delay at SDA output for reliably generating start/stop conditions.

The key I²C IP core features of CrossLink devices:

- Configurable Master and Slave mode
- Support for 7-bit or 10-bit configurable Slave address
- Multi-master arbitration support
- Clock stretching to ensure data setup time
- Up to 1000 kHz data transfer speed, also supports 400 kHz, 100 kHz, 50 kHz modes
- General call support
- Optional delaying input or output data, or both
- Optional FIFO mode
- Transmit FIFO size is 10 bits x 16 bytes, receive FIFO size is 10 bits x 32 bytes
- I2C0 core supports sleep mode wakeup over I²C (refer to Power Management and Calculation for CrossLink Devices (FPGA-TN-02018) for more details)



3. Generating I²C Module with Clarity Designer

The Clarity Designer tool of Lattice Diamond is used to configure the I²C hard IP functions and generate the I²C module.

3.1. Hard IP Enables

Follow these steps to enable Hard Users I²C blocks:

 On the Lattice Diamond top menu, click Tools, and then Clarity Designer. With a CrossLink device targeted for the Diamond project, the Clarity Designer window appears and the I²C module is listed under Module > Architecture_Modules as shown in Figure 3.1.

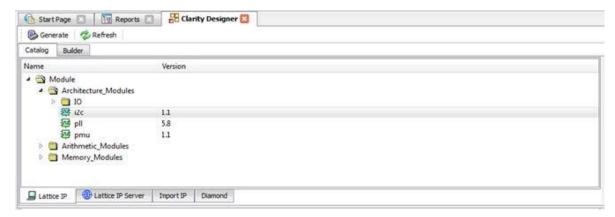


Figure 3.1. I²C Module in Clarity Designer

- 2. Click i2c. The Lattice FPGA module I2C window appears as shown in Figure 3.2.
- 3. On the **Hard IP Enables** tab, select the desired I2C core (I2CO or I2C1, or both), and enter your System Bus clock frequency. The **I2C Settings** and **I2C Interrupts** tabs are enabled when at least one of the Enable Hard Users I2C block is selected.

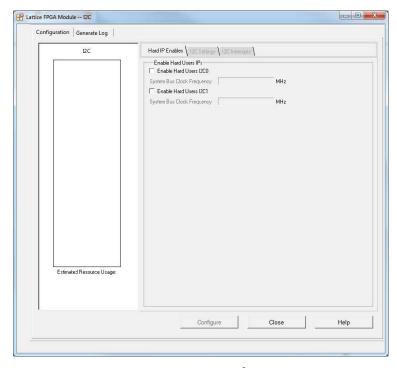


Figure 3.2. Enabling Hard I²C IP Blocks



3.2. I2C Settings

This section describes the I2C Settings tab of Lattice FPGA Module – I2C window as shown in Figure 3.3.

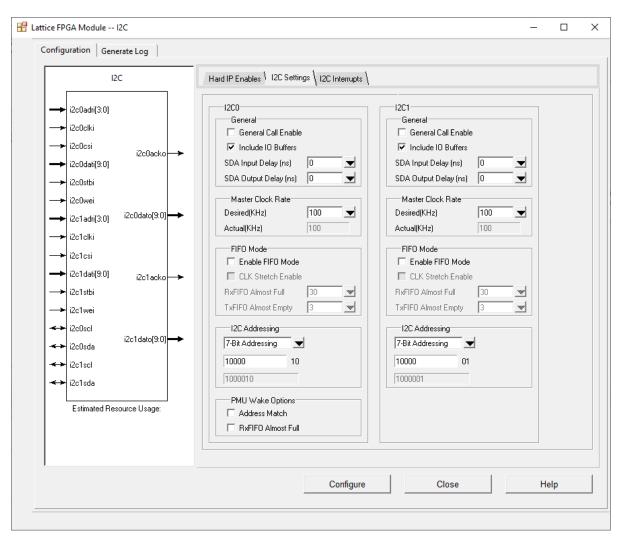


Figure 3.3. I²C Settings

3.2.1. General Settings

3.2.1.1. General Call Enable

Select this checkbox to enable I²C General Call response (addresses all devices on the bus using the I²C address 0) in Slave mode. This setting can be modified dynamically by enabling the GCEN bit in the I²C Control Register I2CCR1. Refer to Advanced CrossLink I2C Hardened IP Reference Guide (FPGA-TN-02020) for register descriptions.

3.2.1.2. Include I/O Buffers

Select this checkbox to include buffers for the I²C pins. Note that I2CO pins are hard routed through I/O buffer to the dedicated pins on the device. These buffers need to be included with I2CO.

Figure 3.4 and Figure 3.5 show the I2C I/O buffer and connections, respectively.



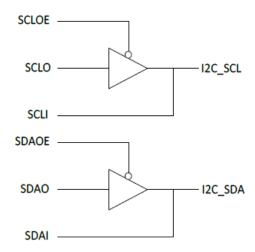


Figure 3.4. I²C I/O Buffer

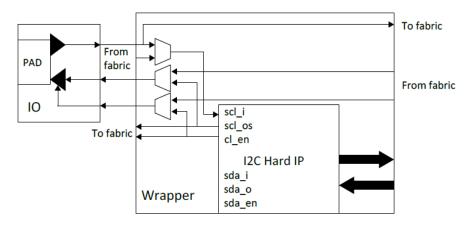


Figure 3.5. I²C I/O Connections

3.2.1.3. SDA Input Delay

Select SDA Input Delay between 0 ns and 50 ns.

3.2.1.4. SDA Output Delay

Select SDA Output Delay between 0 ns and 350 ns.

3.2.2. Master Clock Rate

3.2.2.1. Master Clock Desired

In the Master Clock Desired field you can specify a desired Master clock frequency (in kHz). A calculation is then made to determine a divider value to generate a clock close to this value from the input clock. The frequency of the input System Bus clock is specified on the **Hard IP Enables tab**. The divider value is rounded to the nearest integer after dividing the input System Bus clock by the value entered in this field.



3.2.2.2. Master Clock Actual

This is a read-only field. It is not always possible to divide the input System Bus clock to the exact value requested by the user, therefore the actual value (in kHz) is returned in this field. When both the desired I2C clock and System Bus clock fields contain valid data and either is updated, the Master Clock field returns the value (FREQ_SB/L2C_CLK_DIVIDER), rounded to an integer as shown in the example below. FREQ_SB is the System Bus clock frequency that has been entered on the **Hard IP Enables** tab. I2C_CLK_DIVIDER is a factor to be calculated as in the

Master Clock calculation example:

example below.

- Divider = I2C_CLK_DIVIDER = FREQ_SB/I2C_CLK_FREQ
- Master Clock (Actual) = FREQ_SB/Divider Integer

For example, if FREQ SB = 42.5 MHz and I2C BUS PERF = 400 kHz.

Divider = 42500/400 = 106.25

Therefore, ROUND Divider Integer = 106

Actual frequency = 42500/106 = 400.9 kHz

The tool automatically calculates and displays the Actual I2C Master clock rate value based on the System Bus Frequency and Desired Master Clock rate selected.

In this example, if an I2C_CLK_FREQ of 400 kHz cannot be generated, you may use the actual value or change the System Bus clock frequency.

3.2.3. FIFO Mode

3.2.3.1. Enable FIFO Mode

Select this option to enable FIFO mode operation.

3.2.3.2. CLK Stretch Enable

Select this checkbox to enable Clock Stretching for FIFO mode. This setting may be used to ensure valid data is transmitted from the FIFO. If disabled, then overflow and underflow error flag must be monitored. The Clock Stretch for Register mode is a separate control and can be enabled or disabled through the "CKSDIS" (bit2) inside I2CCMDR register. The I2CCMDR register can be directly accessed through the System Bus. Refer to Advanced CrossLink I2C Hardened IP Reference Guide (FPGA-TN-02020) for more details.

3.2.3.3. RxFIFO Almost Full

Select the value from the list, as to when the RxFIFO's Almost Full Flag must be triggered. The maximum FIFO size of the RxFIFO is 32 bytes.

3.2.3.4. TxFIFO Almost Empty

Select the value from the list, as to when the TxFIFO's Almost Empty Flag must be triggered.

3.2.4. I²C Addressing

In the I²C Address box, you can choose between 7-bit or 10-bit addressing, and define the Hard I²C address.

The lower two significant bits of the I²C address are fixed for each core. You can set the upper 5 significant bits in case of 7-bit addressing, or the upper 8 significant bits in case of 10-bit addressing.

3.2.5. PMU Wake Options

This option is available for I2CO only to enable the Wakeup port. The WKUPEN bit in the I2CCR1 can be modified dynamically allowing the Wake Up function to be enabled or disabled.

3.2.5.1. Address Match

Select this checkbox to turn on the I²C wakeup on address match.



3.2.5.2. RxFIFO Almost Full

Select this checkbox to turn on the I²C wakeup on RxFIFO's Almost Full Flag assertion.

3.3. I²C Interrupts

This section describes the I^2C Interrupts tab of Lattice FPGA Module – I^2C window as shown in Figure 3.6.

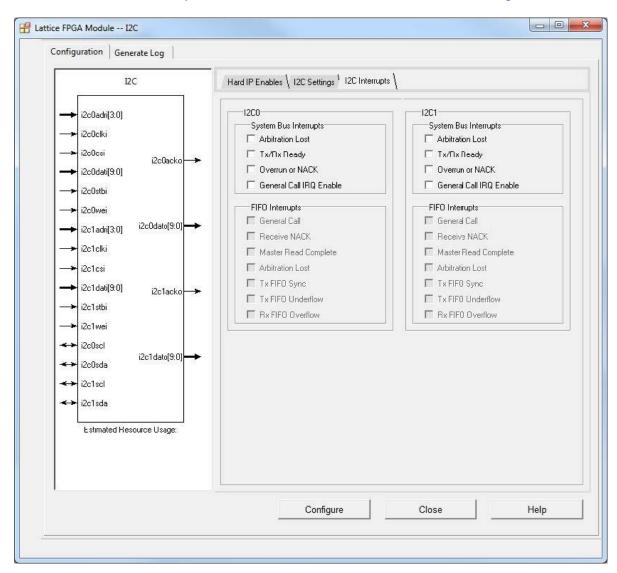


Figure 3.6. I²C Interrupts



3.3.1. System Bus Interrupts

System Bus interrupts enable the interrupt port when any of the interrupts are enabled. Refer to Advanced CrossLink I2C Hardened IP Reference Guide (FPGA-TN-02020) for more details on the interrupt registers described below.

3.3.1.1. Arbitration Lost

This interrupt indicates I²C lost arbitration. This interrupt is bit ARBL of register I2CINTSR. When enabled, it indicates that ARBL is asserted. Writing 1 to this bit clears the interrupt.

This option can be changed dynamically by modifying bit ARBLEN in register I2CINTCR.

3.3.1.2. Tx/Rx Ready

This interrupt indicates that the I^2C transmit data register (I2CTXDR) is empty or that the receive data register (I2CRXDR) is full. This interrupt is bit TRRDY of register I2CINTSR. When enabled, it indicates that TRRDY is asserted. Writing 1 to this bit clears the interrupt.

This option can be changed dynamically by modifying bit TRRDYEN in register I2CINTCR.

3.3.1.3. Overrun or NACK

This interrupt indicates that the I2CRXDR received new data before the previous data. This interrupt is bit TROE of register I2CINTSR. When enabled, it indicates that TROE is asserted. Writing 1 to this bit clears the interrupt.

This option can be changed dynamically by modifying bit I2CINTSR in register I2CINTCR.

3.3.1.4. General Call IRQ Enable

This interrupt indicates that a general call has occurred. This interrupt is bit HGC of register I2CINTSR. When enabled, it indicates that HGC is asserted. Writing 1 to this bit clears the interrupt.

This option can be changed dynamically by modifying bit HGCEN in register I2CINTCR.

3.3.2. FIFO Interrupts

3.3.2.1. General Call

This interrupt indicates that a general call has occurred. This interrupt is bit HGC of register I2CFIFOINTSR.

This bit can be changed by modifying bit HGCEN in register I2CFIFOINTCR.

3.3.2.2. Receive NACK

This interrupt indicates that a NACK has been received. This interrupt is bit RNACK of register I2CFIFOINTSR.

This bit can be changed by modifying bit RNACKEN in register I2CFIFOINTCR.

3.3.2.3. Master Read Complete

A transaction is considered complete when:

- The specified number of data bytes from the Slave have been received in the RX FIFO, or
- The Master terminates the read transaction before the specified number of data bytes received

This is bit MRDCMPL of register I2CFIFOINTSR. This bit can be changed by modifying bit MRDCMPLEN in register I2CFIFOINTCR.

3.3.2.4. Arbitration Lost

This interrupt indicates I2C lost arbitration. This interrupt is bit ARBL of register I2CFIFOINTSR. When enabled, it indicates that ARBL is asserted. Writing 1 to this bit clears the interrupt.

This option can be changed dynamically by modifying bit ARBLEN in register I2CFIFOINTCR.

3.3.2.5. TX FIFO SYNC

This interrupt indicates I2C TXFIFO synchronization error. Synchronization error happens when there are back-to-back commands in the FIFO. The previous command is overwritten. This interrupt is bit TXSERR of register I2CFIFOINTSR. This option can be changed dynamically by modifying bit TXSERREN in register I2CFIFOINTCR.

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3.3.2.6. TX FIFO Underflow

This interrupt is mutually exclusive with clock stretching function. This interrupt is bit TXUNDERF of register I2CFIFOINTSR.

This option can be changed dynamically by modifying bit TXUNDERFEN in register I2CFIFOINTCR.

3.3.2.7. RX FIFO Overflow

This interrupt is mutually exclusive with clock stretching function. This interrupt is bit RXOVERF of register I2CFIFOINTSR.

This option can be changed dynamically by modifying bit RXOVERFEN in register I2CFIFOINTCR.



4. SB_I2C Hardened IP Macro Ports and Wrapper Connections

When the I²C Hardened IP is enabled, the necessary signals are included in the generated module.

Table 4.1. Pins for I²C Hardened IP

Port Name	I ² C Wrapper Name	Pin Direction	Description
SBCSi	i2cXcsi*	Input	Chip select signal. Activates the IP to allow the System Bus or fabric interface to communicate with the IP.
SBCLKi	i2cXclki*	Input	System clock input.
SBWRi	i2cXwei*	Input	System read/write input. R=0, W=1
SBSTBi	i2cXstbi*	Input	System strobe signal. When asserted, indicates that the Slave component is selected.
SBADRi[3:0]	i2cXadri[3:0]*	Input	System bus control registers address.
SBDATi[9:0]	i2cXdati[9:0]*	Input	System data input [7:0] for register mode; [9:0] for FIFO mode.
SBDATo[9:0]	i2cXdato[9:0]*	Output	System data output [7:0] for register mode; [9:0] for FIFO mode.
SBACKo	i2cXacko*	Output	System acknowledgement
SBSRWo	i2cXsrdwr*	Output	Slave read/write signal. A "1" indicates a Slave transmitting (external Master receiving). A "0" means Slave receiving (external Master transmitting).
I2CPIRQ	i2cXi2cirq*	Output	Interrupt request output signal of the I ² C core – The intended use of this signal is for it to be connected to a Master controller (such as a microcontroller or state machine) and request an interrupt when a specific condition is met.
I2CPWKUP	i2cXi2cwkup*	Output	Wake-up signal – The signal is enabled only if the Wakeup Enable feature is set.
FIFO_RST	i2cXfiforst*	Input	Reset for the FIFO logic.
TXFIFO_AE	i2cXtxfifoae*	Output	TXFIFO almost empty status signal coming from TXFIFO, indicating user-defined almost empty threshold value is reached.
TXFIFO_E	i2cXtxfifoe*	Output	TXFIFO empty signal coming from TXFIFO.
TXFIFO_F	i2cXtxfifof*	Output	TXFIFO full signal.
RXFIFO_E	i2cXrxfifoe*	Output	RXFIFO is empty. It can be served as an active low DATA RDY signal.
RXFIFO_AF	i2cXrxfifoaf*	Output	RXFIFO almost full signal, indicating user-defined almost full threshold value is reached.
RXFIFO_F	i2cXrxfifof*	Output	RXFIFO full signal.
MRDCMPL	i2cXmrdcmpl*	Output	Master Read Complete – This is only valid for Master Read Mode. A transaction is considered complete when: The specified number of data bytes from the Slave has been received in the RX FIFO, or The Master terminates the read transaction before the specified number of data bytes received
I2CX_SCL*	i2cXscI*	Bi-directional	Open drain clock line of the I ² C core – The signal is an output if the I ² C core is performing a Master operation. The signal is an input for Slave operations. The "I2C0_SCL" signal (Right I ² C) uses dedicated I/O pin only. The "I2C1_SCL" signal (Left I ² C) can use any of the available GPIOs on the device.
I2CX_SDA*	i2cXsda*	Bi-directional	Open drain data line of the I ² C core – The signal is an output when data is transmitted from the I ² C core. The signal is an input when data is received into the I ² C core. The "I2CO_SDA" signal (Right I ² C) uses dedicated I/O pin only. The "I2C1_SDA" signal (Left I ² C) can use any of the available GPIOs on the device.

Note: X indicates the I^2C : X=0 for the hard I/O pin I^2C ; X=1 for the selectable I/O pin I^2C .



5. I²C Usage Cases

The I²C usage cases described below refer to Figure 5.1.

- CrossLink as I²C Master accessing Slave I²C devices.
- A System Bus Master is implemented in the CrossLink logic.
- I²C devices 1, 2, and 3 are all Slave devices.
- The Master performs bus transactions to the I2C0 I2C controller to access external Slave I2C Device 1 on Bus A.
- The Master performs bus transactions to the I2C1 I2C controller to access the external Slave I²C Device 2 or Device 3 on Bus B.
- External Master I²C device accessing Slave CrossLink I2C.
- The I²C Devices 1, 2, and 3 are I2C Master devices.
- The external Master I²C Device 1 on Bus A performs I²C memory cycles to access the I2C0 I²C controller using address yyyxxxxx01.
- The external Master I²C Device 2 or 3 on Bus B performs I²C memory cycles to access the I2C1 I²C user with the address yyyxxxxx10.
- The System Bus Master in the CrossLink fabric must manage data reception and transmission. The System Bus Master can use interrupts or polling techniques to manage data transfer, and to prevent data overrun conditions.

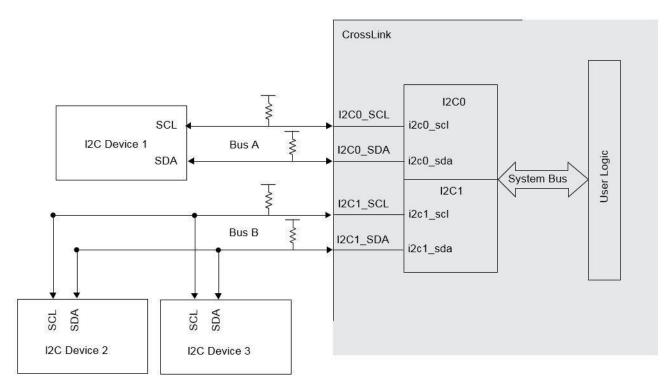


Figure 5.1. I²C Circuit



References

For more information, refer to the following documents:

- CrossLink Family Data Sheet (FPGA-DS-02007)
- CrossLink High-Speed I/O Interface (FPGA-TN-02012)
- CrossLink Hardware Checklist (FPGA-TN-02013)
- CrossLink Programming and Configuration Usage Guide (FPGA-TN-02014)
- CrossLink sysCLOCK PLL/DLL Design and Usage Guide (FPGA-TN-02015)
- CrossLink sysI/O Usage Guide (FPGA-TN-02016)
- CrossLink Memory Usage Guide (FPGA-TN-02017)
- Power Management and Calculation for CrossLink Devices (FPGA-TN-02018)
- Advanced CrossLink I2C Hardened IP Reference Guide (FPGA-TN-02020)



Technical Support Assistance

Submit a technical support case through www.latticesemi.com/techsupport.



Revision History

Revision 1.1, December 2020

Section	Change Summary
Disclaimers	Added this section.
Introduction	Updated information on I2CO dedicated I/O pins.
Generating I ² C Module with Clarity Designer	Updated Figure 3.3. I ² C Settings.
SB_I2C Hardened IP Macro Ports and Wrapper Connections	Updated descriptions of I2CX_SCL and I2CX_SDA ports in Table 4.1. Pins for I ² C Hardened IP.

Revision 1.0, August 2016

Section	Change Summary	
All	Updated document numbers.	

Revision 1.0, May 2016

Section	Change Summary
All	First preliminary release.



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